#### **General Description**

The MAX20037 evaluation kit (EV kit) demonstrates the MAX20037 automotive high-current step-down DC-DC converter with USB protection/host charger adapter emulation.

The IC features integrated host-charger portdetection circuitry adhering to the USB-IF BC1.2 batterycharging specification, Apple<sup>®</sup> iPod<sup>®</sup>/iPhone<sup>®</sup>/iPad<sup>®</sup> and Samsung<sup>®</sup> charge-detection termination resistors, and Chinese Telecommunication Industry Standard YD/T 1591-2009.

The IC integrates high-side current-sensing and voltageadjustment circuitry that provides automatic USB voltage adjustment to compensate for voltage drops in captive cables associated with automotive applications.

The high-efficiency, step-down, synchronous, DC-DC converter operates from a voltage up to 28V and is protected from load-dump transients up to 40V. The converter is programmable for frequencies from 275kHz to 2.2MHz and can deliver 3A of continuous current at 105°C.

The EV kit is populated with an I<sup>2</sup>C-enabled MAX20037. The I<sup>2</sup>C interface allows for flexible configuration, detailed fault diagnostics, and access to the on-chip ADC that reports output voltage and current. The I<sup>2</sup>C features are easily accessed by using the Maxim command module (MINIQUSB) along with the provided example GUI.

The EV kit is configured for 2.2MHz operation, and the included 3m USB cable allows for demonstration of the cable-compensation capability of the IC. The EV kit comes with data-line tuning component pads populated with short circuits. Tuning components are usually not necessary for the low voltage, high-bandwidth data switches in MAX20037. Refer to Figure 17 in the MAX20037/MAX20038 IC data sheet for the MAX20037 untuned near-eye diagram.

Apple, iPod, iPhone, and iPad are registered trademarks of Apple Inc.

#### **Benefits and Features**

- Configurable Charge-Detection Modes
  - USB-IF BC1.2 CDP, DCP
  - Apple 2.4A, 1.0A
  - China YD/T1591-2009 Charging Specification
- Automatic USB Voltage Adjustment by Integrated DC-DC Converter (275kHz to 2.2MHz)
- Proven PCB Layout
- Fully Assembled and Tested

#### **Quick Start**

The following procedure demonstrates the MAX20037's voltage-adjustment capability and I<sup>2</sup>C interface.

#### **Required Equipment**

- MAX20037 EV kit
- MINIQUSB command module and MAX20037 example GUI
- Included 3m USB captive cable
- 2Ω, 20W resistor or electronic load connected to a Type-A USB 2.0 connector (plug)
- 12V, 2A DC power supply or car battery (Supply A)
- 3.3V, 1A DC power supply (Supply B)
- Two digital voltmeters (DVM1, DVM2) or one oscilloscope

Ordering Information appears at end of data sheet.

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#### Procedure

The EV kit is fully assembled and tested. Follow the steps below to verify board operation:

- Connect Supply A (turned off) between the VBAT and GND test points.
- Connect Supply B (turned off) between the 3V3 header and GND test point.
- Connect the USB cable, but leave the load disconnected.
- Connect DVM1 (or oscilloscope channel 1) between the USB\_5V and GND test points on the EV kit (this is the output of the buck).
- 5) Connect DVM2 (or oscilloscope channel 2) to VBUS and GND at the far-end of the USB cable (this is the voltage a portable device sees).
- 6) Power on Supply A at 12V with a 2A current limit and Supply B at 3.3V with a 0.2A current limit.
- Both DVM1 and DVM2 should measure approximately 5V.
- 8) Establish I<sup>2</sup>C communication with the GUI:
  - a) Visit <u>https://www.maximintegrated.com/en/</u> <u>design/tools/applications/evkit-software/</u> <u>index.mvp?id=1330</u> to download and install the MAX20037 example GUI and MINIQUSB drivers.
  - b) Using the supplied jumper wires, connect the MINIQUSB pins labeled SDA, SCL, and GND to the appropriate EV kit headers.
  - c) Connect the MINIQUSB module to a PC through a USB cable.
  - d) Open the MAX20037 example GUI; look at the message bar at the bottom of the GUI to verify that both the MINIQUSB and the EV kit are detected.

- 9) Connect the load to the end of the USB cable.
- With the voltage adjustment disabled (GAIN = 0x0; default setting), measure the voltage:
  - a) The voltage at the buck output (USB\_5V) should still be approximately 5V. There is a slight drop due to load regulation and the current through the current-sense resistor, output filter, and PCB trace.
  - b) The voltage at the far end of the USB cable will be noticeably below 5V. The voltage drop is caused by the load current flowing through the cable resistance.
- 11) Using the GAIN drop-down list in the GUI, set the gain to  $661m\Omega$ , which is the maximum setting.
- 12) The voltage at the buck output should increase to 6.8V, and the voltage at the end of the USB cable should now be approximately 5V.
- 13) The far-end voltage can be fine-tuned by adjusting the GAIN register to match the specific cable. Once the GAIN register is adjusted correctly, the far-end voltage should maintain 5V regardless of load current.

#### **Optional: Using the On-Chip ADC**

- 14) Ensure that the **Read V/I ADC** and **Auto Read** checkboxes are checked.
- Click on the Int ADC V/I Done checkbox. USB\_V and USB\_I will update with the voltage on SENSP and the voltage across R<sub>SENSE</sub>, respectively.
  - a) The ADC values update once for every write of Int ADC V/I Done.

#### **Detailed Description**

The MAX20037 EV kit comes fully assembled, tested, and installed with a MAX20037ATIA/V+ IC. Both standalone and high-voltage variants can be used on this EV kit by changing the IC and configuration resistors.

#### **EV Kit Interface**

Header J1 includes input and output test points for controlling the IC and evaluating its functionality. <u>Table 1</u> lists the individual pins and their functions.

Switch SW1 allows the user to switch the value on the HVEN, ENBUCK, SYNC, and CDP\_DCP pins. Setting the switch to the ON/1 position ties the connected pin to the 3.3V supply and setting the switch to the OFF/0 position ties the pin to ground. To externally control these pins through the J1 header, set the switch to the OFF/0 position. This leaves the pin connected to the header with a pulldown resistor. Table 2 describes the switch and its functionality.

Connect the battery-voltage input between the VBAT and GND test loops and 3.3V to the 3V3 pin on J1. The IC's DC-DC converter output voltage can be measured between the USB\_5V and GND test points, or between the ground and VBUS pins of the USB connector. To disable the voltage-adjustment feature, set the GAIN register to zero (default). Setting the HVEN switch to one pulls the HVEN pin to 3V3 and enables the device. SYNC can be pulled to the 3V3 node for forced-PWM operation (when configured as an input), or configured to output the internal oscillator. Pull the ENBUCK pin low to disable DC-DC converter operation. The FAULT output is active low. The charge mode can be configured through I<sup>2</sup>C, by starting the part with the CDP/DCP pin low. Refer to the MAX20037/MAX20038 IC data sheet for details

#### Table 1. External Header (J1)

PIN	NAME	DESCRIPTION	
1	3V3	EV kit 3.30V (input)	
2	SYNC	Buck regulator SYNC (input/output)	
3	CDP/DCP	Charge-detection configuration pin (input)	
4	HVEN	Active-high IC enable (input)	
5	ENBUCK	Active-high DC-DC enable (input)	
6	FAULT	Active-low fault indicator (output)	
7	INT (ATTACH)	I <sup>2</sup> C interrupt (output)	
8	SCL	l <sup>2</sup> C clock	
9	SDA	l <sup>2</sup> C data	
10	GND	EV kit ground	

#### **PCB Layout Guidelines**

Good PCB layout is critical to proper system performance. The loop area of the DC-DC conversion circuitry must be minimized. Place the input capacitor, power inductor, and output capacitor as close as possible to the IC. Shorter traces should be prioritized over wider traces.

A low-impedance ground connection between the input and output capacitors is necessary (route through the ground pour on the exposed pad). Connect the exposed pad to ground. Place multiple vias in the pad to connect to all other ground layers for proper heat dissipation (failure to do this may result in the IC repeatedly reaching thermal shutdown). Do not use separate power and analog grounds; use a single common ground, as high-frequency return currents flow directly under the corresponding traces.

USB traces must be routed as a  $90\Omega$  differential pair with an appropriate keep-out area. Avoid routing USB traces near high-frequency switching nodes, or other sources of noise such as clocks. The length of the routing should be minimized and avoid  $90^{\circ}$  turns, excessive vias, and RF stubs. RC tuning components are not required for the IC, but are necessary. Place components close to the IC, use high-Q wire-wound inductors, and contact the Maxim applications team for support.

#### PIN POSITION DESCRIPTION Device disabled 0 HVEN 1 Device enabled 0 Buck output disabled ENBUCK 1 Buck output enabled Skip mode (only if configured as 0 an input) SYNC 1 Forced-PWM mode 0 Default to Auto-CDP mode CDP\_DCP 1 Keep pin low on I<sup>2</sup>C variant

#### Table 2. External Switch (SW1)

#### **Ordering Information**

PART	TYPE
MAX20037EVKIT#	EV Kit

#Denotes RoHS compliant.

C1

C2

C3

C4

C5

D1

D2

J1

J2

J3

L1

L2

L5

R1

U1

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#### REFERENCE QTY DESCRIPTION MANUFACTURER MFG. PART NO. Murata GCM216R72A222KA37D 1 Ceramic Capacitor (0805) 2.2nF 100V 10% X6S 1 Electrolytic Capacitor (SMD) 47uF 25V 20% Panasonic EEE-HC1E470XP TDK CGA2B1X7R1V224KC 1 Ceramic Capacitor (0402) 0.22uF 35V 10% X7R 1 Open Ceramic Capacitor (1206)10uF 35V 10% X7R TDK CGA5L1X7R1V106KC 1 C6, C7 2 GRM32ER71E226KE5L Ceramic Capacitor (1210) 22uF 25V 10% X7R Murata C8, C9 2 Ceramic Capacitor (0402) 1uF 16V 10% X6S TDK C1005X6S1C105K C10, C11 2 Ceramic Capacitor (0402) 6pF 50V 10% C0G Murata GRM1555C1H6R0BZ01D C12, C20 1 Ceramic Capacitor (0402) 0.1uF 50V 10% X7R TDK CGA2B3X7R1H104K050BD C13. L14 2 Ceramic Capacitor (0402) 2pF 50V 10% C0G Murata GRM1555C1H2R0BA01D C15 1 Ceramic Capacitor (0603) 2.2uF 16V 10% X7S TDK CGA3E1X7S1C225KC C16 1 TDK CGA2B2C0G1H101J050BA Ceramic Capacitor (0402) 100pF 50V 5% C0G C17, C21, C22, C23 4 Open 1 Open B360B-13-F 1 Schottky Diode (SMB) 3A 60V Diodes Inc GND, GND1, USB 5V, VBAT 4 Wire Loop Any Any 1 1x10 .100" Gold Header + 1 Jumper Any Any 1 USB A Receptacle KUSBX-SMT-AS1N-B30 Kycon 1 USB A Plug Kycon KUSBX-SMT2AP5S-B 1 Ferrite Bead (1206) Wurth 74279218 BLM41P600S 1 Ferrite Bead (1806) Murata L3, L4 2 Inductor (0402) 12nH ±2% wire-wound Murata LQW15AN12NG00 1 Inductor, 1.5uH, 8.5A Isat Coilcraft XEL4030-152MEB Inductor (0402) 4.7nH ±1nH wire-wound L6, L7 2 Murata LQW15AN4N7B00 Resistor (1206) .033 Ohm 0.5% Ohmite LVK12R033DER 1 R2. R8, R9, R10, R11, R12, R13, R14 8 Resistor (0402) 100k Ohm 1% Any Any R3, R4, R5, R6, R7, R15, R16 7 Open R17 Resistor (0402) 0 Ohm 1 Any Any SW1 1 1.27mm Pitch DIP Switch **C&K** Components TDA04H0SB1R 1 USB Protection and Power IC Maxim Integrated MAX20037ATIA/V+

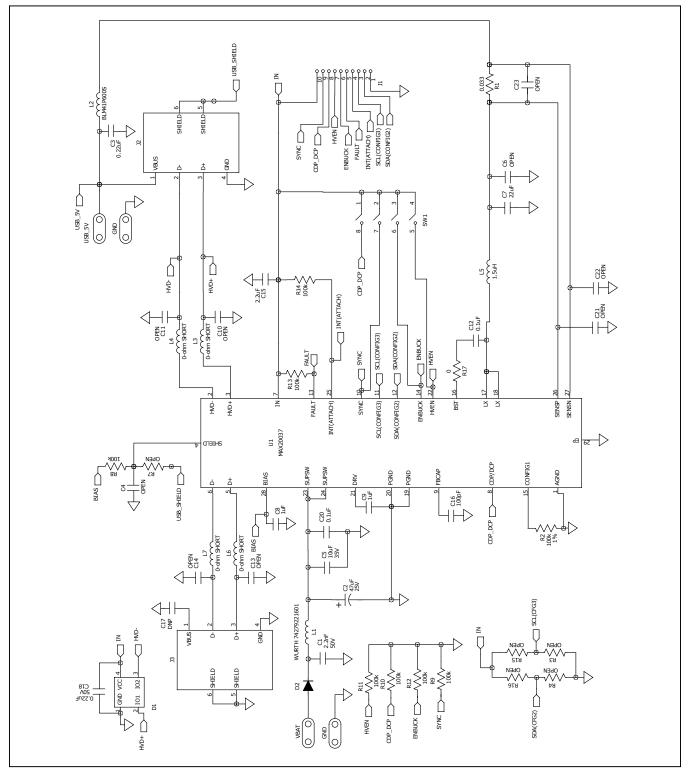
PCB: MAX20037 EVALUATION KIT

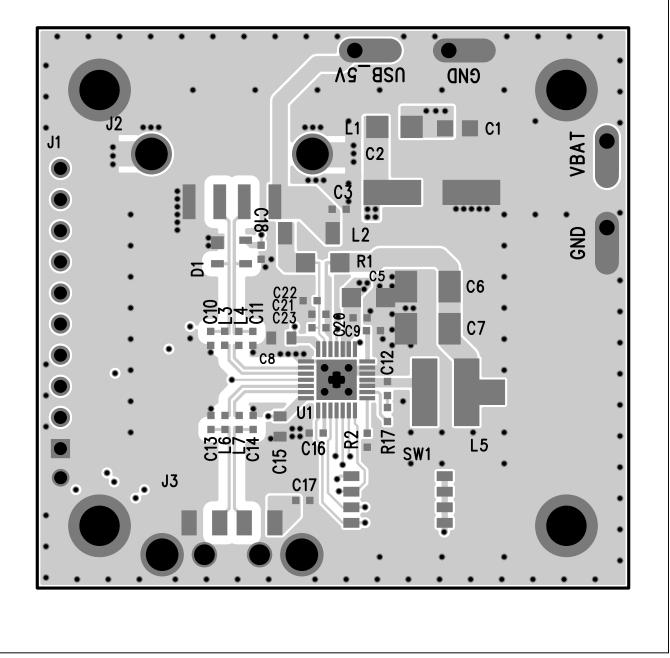
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#### MAX20037 EV Kit Bill of Materials

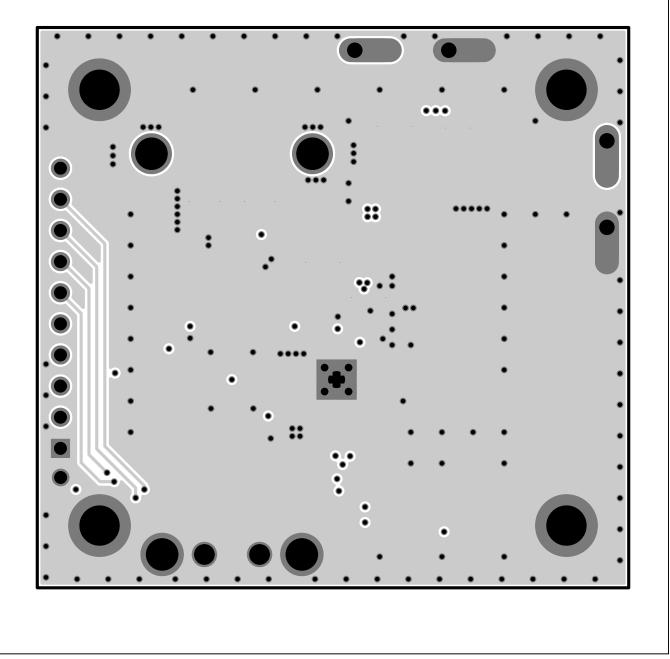
### MAX20037 EV Kit Schematic



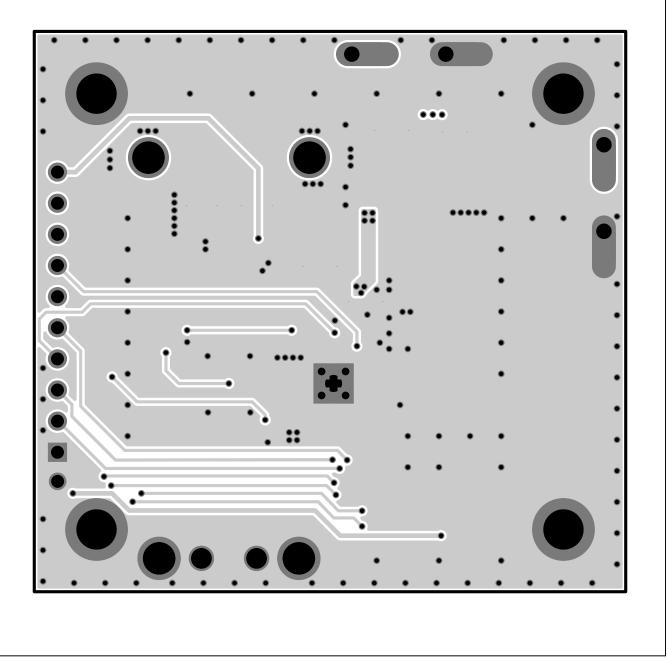


### MAX20037 EV Kit PCB Layouts

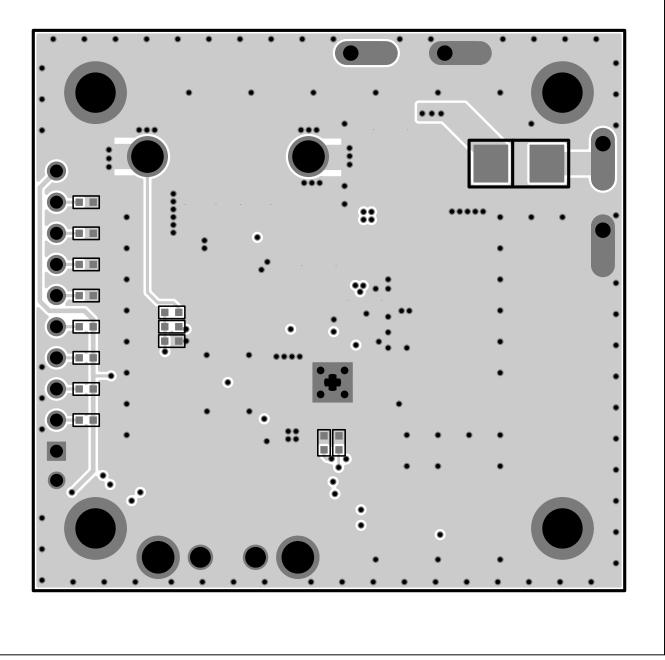
MAX20037 EV Kit PCB Layout—Top Layer



MAX20037 EV Kit PCB Layout—Layer 2

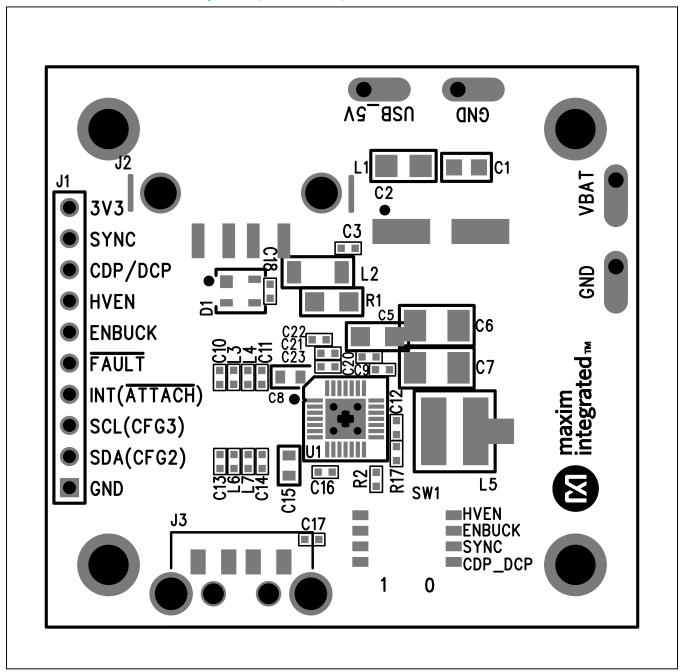


MAX20037 EV Kit PCB Layout—Layer 3

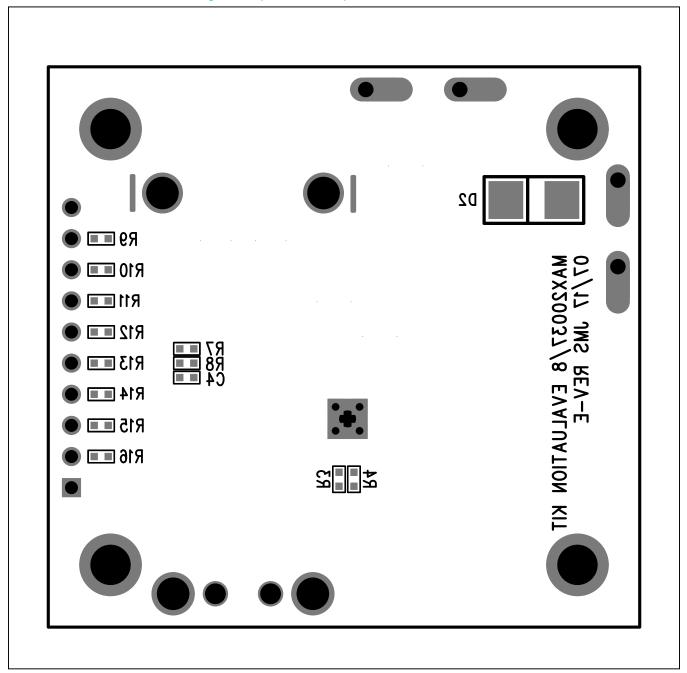


## MAX20037 EV Kit PCB Layouts (continued)

MAX20037 EV Kit PCB Layout—Bottom Layer



MAX20037 EV Kit Component Placement Guide—Top Silkscreen



MAX20037 EV Kit Component Placement Guide—Bottom Silkscreen

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#### **Revision History**

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	2/18	Initial release	—

For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim Integrated's website at www.maximintegrated.com.

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